# imall

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International **TOR** Rectifier

Preliminary Data Sheet No. PD60063I

# IR2154

### SELF-OSCILLATING HALF-BRIDGE DRIVER

#### **Features**

- Integrated 600V half-bridge gate driver
- 15.6V zener clamp on Vcc
- True micropower start up
- Tighter initial deadtime control
- Low temperature coefficient deadtime
- Shutdown feature (1/6th Vcc) on C<sub>T</sub> pin
- Increased undervoltage lockout Hysteresis (1V)
- Lower power level-shifting circuit
- Constant LO, HO pulse widths at startup
- Lower di/dt gate driver for better noise immunity
- High side output in phase with RT
- Excellent latch immunity on all inputs and outputs
- ESD protection on all leads

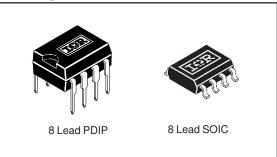
#### Description

The IR2154 is an improved version of the popular IR2152 gate driver IC, and incorporates a high voltage half-bridge gate driver with a front end oscillator similar to the industry standard CMOS 555 timer. The IR2154 provides more functionality and is easier to use than previous ICs. A shutdown feature has been designed into the CT pin, so that both gate driver outputs can be disabled using a low voltage control signal. In addition, the gate driver output pulse widths are the same once the rising undervoltage lockout threshold on V<sub>CC</sub> has been reached, resulting in a more stable profile of frequency vs time at startup. Noise immunity has been improved significantly, both by lowering the peak di/dt of the gate drivers, and by increasing the undervoltage lockout hysteresis to 1V. Finally, special attention has been payed to maximizing the latch immunity of the device, and providing comprehensive ESD protection on all pins.

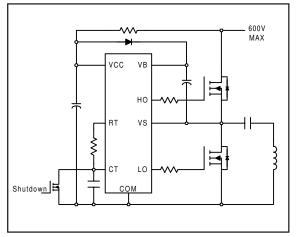
#### Product Summary

VOFFSET	600V max.
Duty Cycle	50%
Tr/Tp	80/40ns
V <sub>clamp</sub>	15.6V
Deadtime (typ.)	1.2 μs

#### **Packages**



#### **Typical Connection**



### IR2154

#### **Absolute Maximum Ratings**

Absolute maximum ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM, all currents are defined positive into any lead. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions.

Symbol	Definition	Min.	Max.	Units	
VB	High side floating supply voltage		-0.3	625	
VS	High side floating supply offset voltage		V <sub>B</sub> - 25	V <sub>B</sub> + 0.3	
VHO	High side floating output voltage		V <sub>S</sub> - 0.3	V <sub>B</sub> + 0.3	
V <sub>LO</sub>	Low side output voltage		-0.3	V <sub>CC</sub> + 0.3	V
V <sub>RT</sub>	R <sub>T</sub> pin voltage		-0.3	V <sub>CC</sub> + 0.3	
V <sub>CT</sub>	C <sub>T</sub> pin voltage		-0.3	V <sub>CC</sub> + 0.3	
ICC	Supply current (note 1)		_	25	mA
I <sub>RT</sub>	R <sub>T</sub> pin current		-5	5	
dV <sub>s</sub> /dt	Allowable offset voltage slew rate		-50	50	V/ns
PD	Maximum power dissipation @ $T_A \le +25^{\circ}C$	(8 Lead DIP)	_	1.0	w
		(8 Lead SOIC)	_	0.625	vv
RthJA	Thermal resistance, junction to ambient	(8 Lead DIP)	_	125	°C/W
		(8 Lead SOIC)	_	200	-0/00
ТJ	Junction temperature		-55	150	
TS	Storage temperature		-55	150	°C
TL	Lead temperature (soldering, 10 seconds)		_	300	

#### **Recommended Operating Conditions**

For proper operation the device should be used within the recommended conditions.

Symbol	Definition	Min.	Max.	Units
V <sub>Bs</sub>	High side floating supply voltage	V <sub>CC</sub> - 0.7	V <sub>CLAMP</sub>	
VS	Steady state high side floating supply offset voltage	-3.0 (note 2)	600	V
Vcc	Supply voltage	10	VCLAMP	
Icc	Supply current	(note 3)	5	mA
TJ	Junction temperature	-40	125	°C

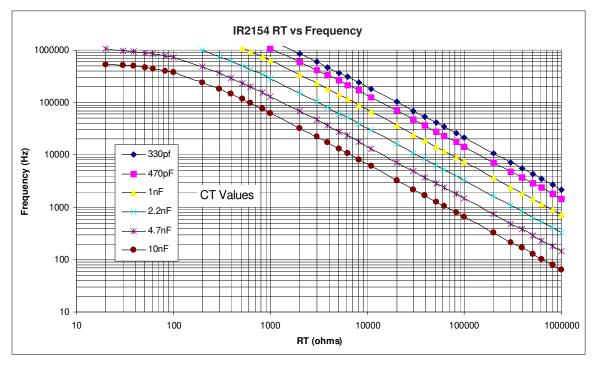
Note 1: This IC contains a zener clamp structure between the chip V<sub>CC</sub> and COM which has a nominal breakdown voltage of 15.6V. Please note that this supply pin should not be driven by a DC, low impedance power source greater than the V<sub>CLAMP</sub> specified in the Electrical Characteristics section.

Note 2: Care should be taken to avoid output switching conditions where the V<sub>S</sub> node flies inductively below ground by more than 5V.

Note 3: Enough current should br supplied to the V<sub>CC</sub> pin of the IC to keep the internal 15.6V zener diode clamping the voltage at this pin.

#### **Recommended Component Values**

Symbol	Component	Min.	Max.	Units
RT	Timing resistor value	10	_	kΩ
CT	C <sub>T</sub> pin capacitor value	330	—	pF



#### **Electrical Characteristics**

 $V_{BIAS}$  (V<sub>CC</sub>, V<sub>BS</sub>) = 12V, C<sub>L</sub> = 1000 pF, C<sub>T</sub> = 1 nF and T<sub>A</sub> = 25°C unless otherwise specified. The V<sub>IN</sub>, V<sub>TH</sub> and I<sub>IN</sub> parameters are referenced to COM. The V<sub>O</sub> and I<sub>O</sub> parameters are referenced to COM and are applicable to the respective output leads: HO or LO.

Low Voltage Supply Characteristics						
Symbol	Definition	Min.	Тур.	Max.	Units	Test Conditions
V <sub>CCUV+</sub>	Rising V <sub>CC</sub> undervoltage lockout threshold	8.1	9.0	9.9		
VCCUV-	Falling V <sub>CC</sub> undervoltage lockout threshold	7.2	8.0	8.8	V	
VCCUVH	V <sub>CC</sub> undervoltage lockout Hysteresis	0.5	1.0	1.5	1	
Ιαςςυν	Micropower startup V <sub>CC</sub> supply current	_	75	150	μΑ	Vcc≤Vccuv-
lacc	Quiescent V <sub>CC</sub> supply current	—	500	950	μπ	
VCLAMP	V <sub>CC</sub> zener clamp voltage	14.4	15.6	16.8	V	$I_{CC} = 5mA$

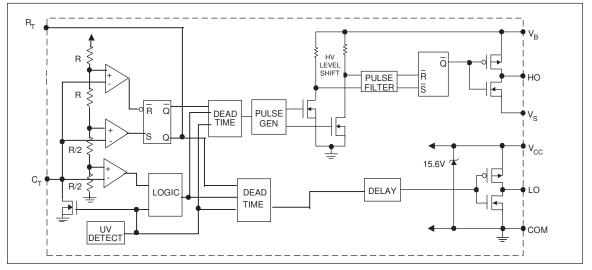
## IR2154

#### International **tor** Rectifier

### Electrical Characteristics (cont.)

Floating	g Supply Characteristics					
Symbol	Definition	Min.	Тур.	Max.	Units	Test Conditions
IQBSUV	Micropower startup V <sub>BS</sub> supply current		0	10		V <sub>CC</sub> ≤ V <sub>CCUV</sub> -
I <sub>QBS</sub>	Quiescent VBS supply current		30	50	μΑ	
V <sub>BSMIN</sub>	Minimum required $V_{BS}$ voltage for proper functionality from $R_T$ to HO	_	4.0	5.0	V	$V_{CC}=V_{CCUV+} + 0.1V$
ILK	Offset supply leakage current		_	50	μΑ	$V_{B} = V_{S} = 600V$
	tor I/O Characteristics					1
Symbol	Definition	Min.	Тур.	Max.	Units	Test Conditions
fosc	Oscillator frequency	19.4	20	20.6	– kHz	R <sub>T</sub> = 36.9kΩ
		94	100	106		RT = 7.43kΩ
d	RT pin duty cycle	48	50	52	%	fo < 100kHz
ICT	CT pin current	_	0.001	1.0	uA	
Істиу	UV-mode CT pin pulldown current	0.30	0.70	1.2	mA	$V_{CC} = 7V$
Vct+	Upper CT ramp voltage threshold	_	8.0	_		
Vст-	Lower CT ramp voltage threshold	—	4.0	—	V	
VCTSD	CT voltage shutdown threshold	1.8	2.1	2.4		
V <sub>RT+</sub>	High-level RT output voltage, VCC - VRT	—	10	50		I <sub>RT</sub> = 100μA
		—	100	300		I <sub>RT</sub> = 1mA
Vrt-	Low-level RT output voltage	—	10	50		I <sub>RT</sub> = 100μA
		_	100	300	mV	I <sub>RT</sub> = 1mA
Vrtuv	UV-mode RT output voltage	_	0	100		$V_{CC} \leq V_{CCUV}$
VRTSD	SD-Mode RT output voltage, VCC - VRT	_	10	50		I <sub>RT</sub> = 100μA, V <sub>CT</sub> = 0V
		-	10	300		I <sub>RT</sub> = 1mA, V <sub>CT</sub> = 0V
Gate D	river Output Characteristics					
Symbol	Definition	Min.	Тур.	Max.	Units	Test Conditions
V <sub>OH</sub>	High level output voltage, VBIAS -VO	-	0	100		I <sub>O</sub> = OA
VOL	Low-level output voltage, VO	—	0	100	mV	I <sub>O</sub> = OA
VOL_UV	UV-mode output voltage, VO	-	0	100		$I_O = OA$ $V_{CC} \le V_{CCUV}$ -
tr	Output rise time	—	80	150		
tf	Output fall time	_	45	100	nsec	
t <sub>sd</sub>	Shutdown propogation delay	—	660	<u> </u>	1	
td	Output deadtime (HO or LO)	0.35	0.60	0.85	μsec	

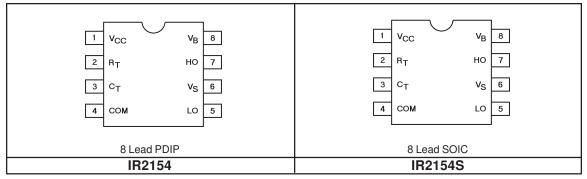
#### **Functional Block Diagram**



#### Lead Definitions

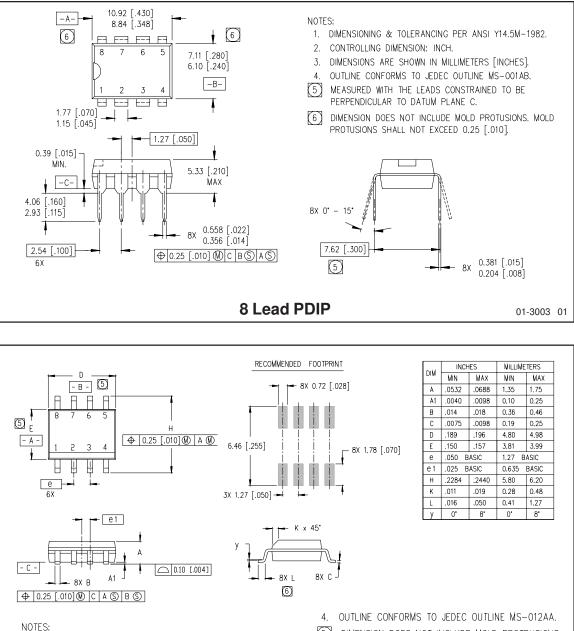
Symbol	Description
V <sub>CC</sub>	Logic and internal gate drive supply voltage
R <sub>T</sub>	Oscillator timing resistor input
CT	Oscillator timing capacitor input
COM	IC power and signal ground
LO	Low side gate driver output
VS	High voltage floating supply return
HO	High side gate driver output
VB	High side gate driver floating supply

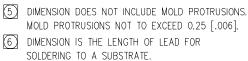
#### Lead Assignments



### IR2154

# International





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8 Lead SOIC

1. DIMENSIONING & TOLERANCING PER ANSI Y14.5M-1982.

DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].

2. CONTROLLING DIMENSION: MILLIMETER.

3.

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### IR2154

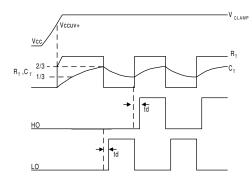
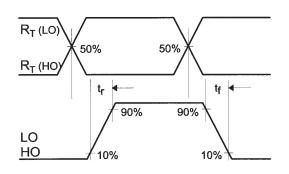


Figure 1. Input/Output Timing Diagram





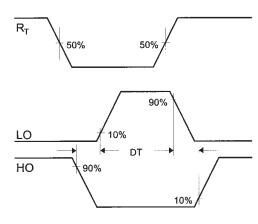


Figure 3. Deadtime Waveform Definitions

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